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FDMC612PZ P-Channel PowerTrench[®] MOSFET -20 V, -14 A, 8.4 m Ω

Features

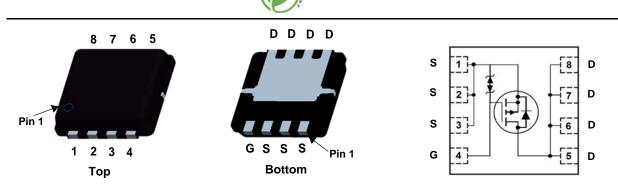
- Max $r_{DS(on)}$ = 8.4 m Ω at V_{GS} = -4.5 V, I_D = -14 A
- Max $r_{DS(on)}$ = 13 m Ω at V_{GS} = -2.5 V, I_D = -11 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- Termination is Lead-free and RoHS Compliant
- HBM ESD capability level > 3.6 KV typical (Note 4)

General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been optimized for $r_{\text{DS(ON)}}$, switching performance and ruggedness.

Applications

- Battery Management
- Load Switch



MLP 3.3x3.3

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Param	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			-20	V	
V _{GS}	Gate to Source Voltage			±12	V	
ID	Drain Current -Continuous	T _C = 25 °C		-40		
	-Continuous	T _A = 25 °C	(Note 1a)	-14	Α	
	-Pulsed			-50		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	38	mJ	
P _D	Power Dissipation	T _C = 25 °C		26	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3	vv	
T _J , T _{STG}	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		4.9	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	53	0/00

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC612PZ	FDMC612PZ	MLP 3.3X3.3	13 "	12 mm	3000 units

October 2013

FDMC612PZ	
P-Channel	
PowerTrench	
	0

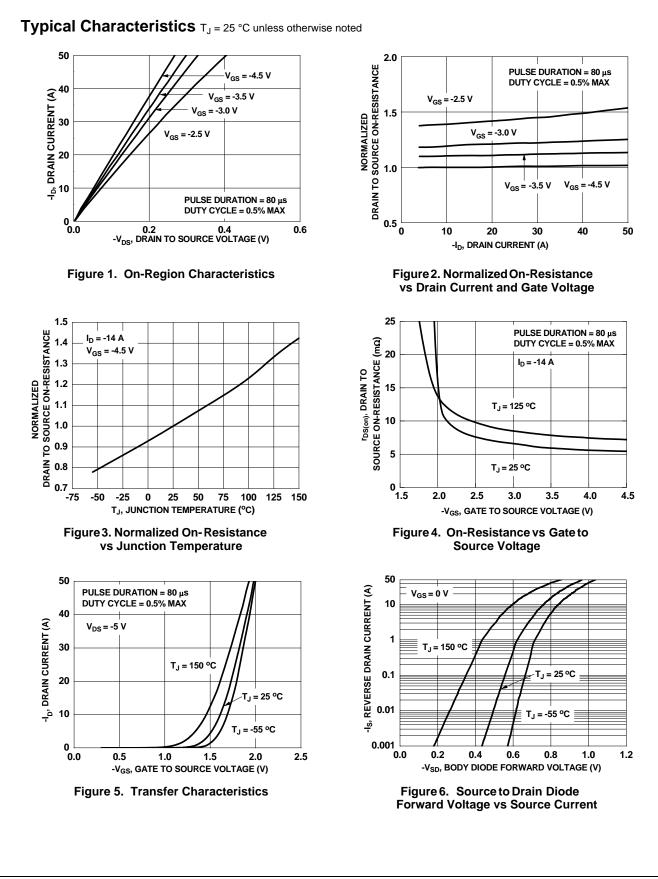
Off Charac	Parameter	Test Conditions	Min	Тур	Max	Units
	teristics			·		
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250 μA, V _{GS} = 0 V	-20			V
	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, referenced to 25 °C		-19		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 V, V_{GS} = 0 V$			-1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ
On Charac	teristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250 μA	-0.6	-0.9	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		9		mV/°C
		V _{GS} = -4.5 V, I _D = -14 A		5.9	8.4	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = -2.5 V, I _D = -11 A		8.2	13	mΩ
		V_{GS} = -4.5 V, I _D = -14 A, T _J = 125 °C		8.3	13	
9 _{FS}	Forward Transconductance	V _{DS} = -5 V, I _D = -14 A		85		S
Dvnamic C	Characteristics					
-	Input Capacitance			5710	7995	pF
C _{oss}	Output Capacitance	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		1215	1700	pF
	Reverse Transfer Capacitance	f = 1 MHz		1170	1640	pF
t _{d(on)}	Characteristics Turn-On Delay Time			26	42	ns
t _r	Rise Time	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -14 \text{ A},$		52	83	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = -4.5 V, R_{GEN} = 6 Ω		96	154	ns
t _f	Fall Time			81	130	ns
Qg	Total Gate Charge	V _{DD} = -10 V, I _D = -14 A,		53	74	nC
Q _{gs}	Gate to Source Charge	$V_{BB} = -4.5 V$		9.4		nC
Q _{gd}	Gate to Drain "Miller" Charge			18		nC
Drain-Sour	rce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -14 A$ (Note 2)		-0.8	-1.3	V
	-	$V_{GS} = 0 V, I_{S} = -2 A$ (Note 2)		-0.7	-1.2	•
	Reverse Recovery Time	I _F = -14 A, di/dt = 100 A/μs		39	62	ns
Q _{rr}	Reverse Recovery Charge			17	31	nC

o PD St S

2: Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0 %. 3: E_{AS} of 38 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = -16 A, V_{DD} = -18 V, V_{GS} = -10 V. 4: The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

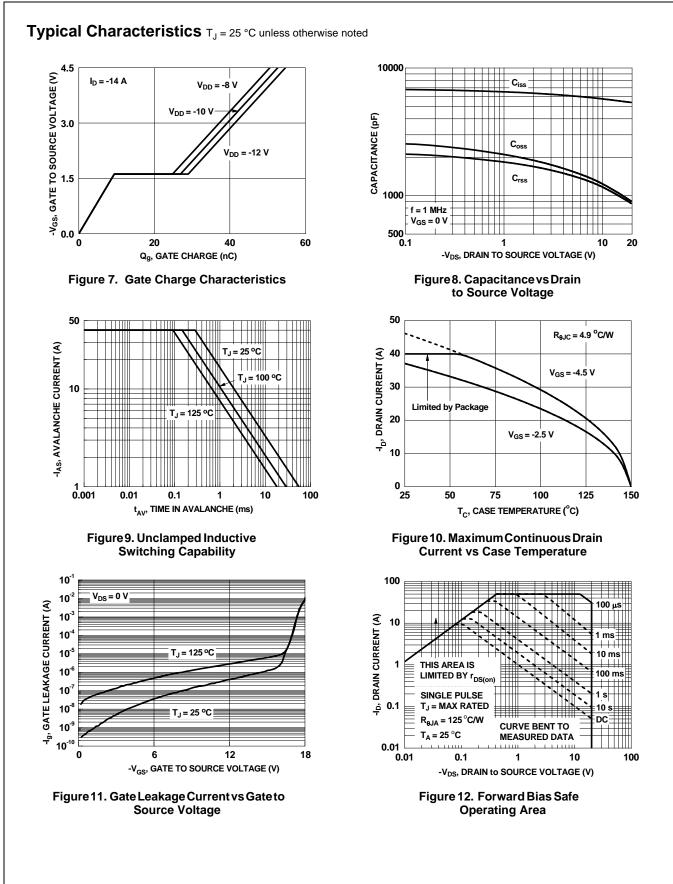
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FDMC612PZ P-Channel PowerTrench[®] MOSFET



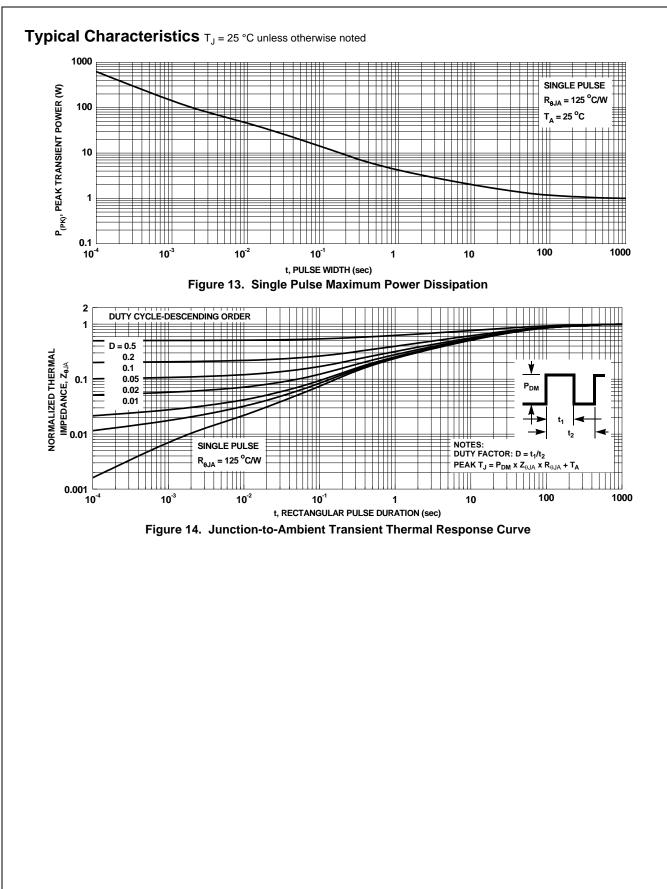
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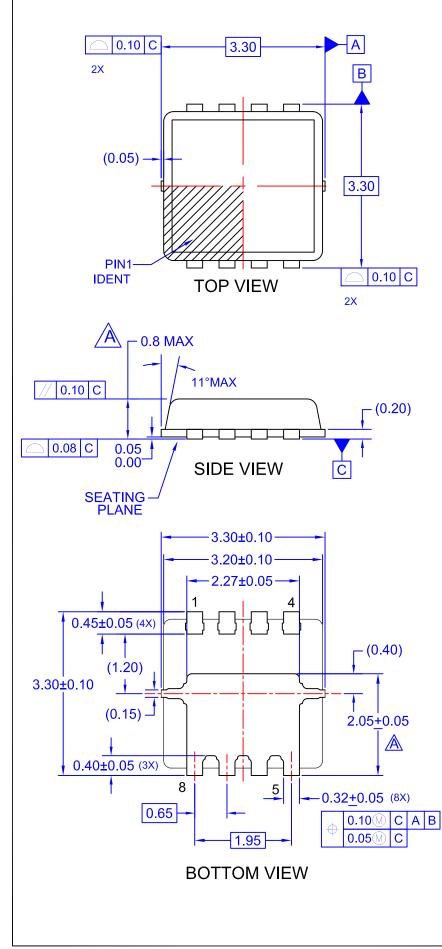


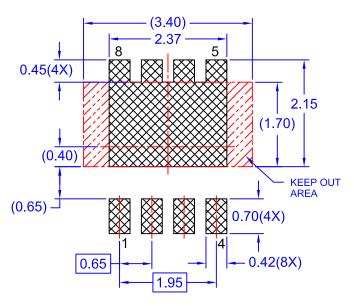


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RECOMMENDED LAND PATTERN

NOTES:

- A EXCEPT AS NOTED, PACKAGE CONFORMS TO JEDEC REGISTRATION MO-240 VARIATION BA.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. SEATING PLANE IS DEFINED BY TERMINAL TIPS ONLY
- E. BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH PROTRUSIONS NOR GATE BURRS.
- F. FLANGE DIMENSIONS INCLUDE INTERTERMINAL FLASH OR PROTRUSION. INTERTERMINAL FLASH OR PROTRUSION SHALL NOT EXCEED 0.25MM PER SIDE.
- G. IT IS RECOMMENDED TO HAVE NO TRACES OR VIA WITHIN THE KEEP OUT AREA.
- H. DRAWING FILENAME: MKT-MLP08Trev4.
- I. GENERAL RADII FOR ALL CORNERS SHALL BE 0.20MM MAX.



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